■ Lighting Color

• Red

LNJ218C8ARU

Surface Mounting Chip LED

Dome-Lens FD Type

■ Absolute Maximum Ratings $T_a = 25$ °C

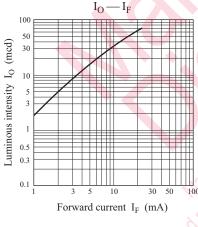
Parameter	Symbol	Rating	Unit	
Power dissipation	P_{D}	60	mW	
Forward current	I_{F}	20	mA	
Pulse forward current *	I_{FP}	60	mA	
Reverse voltage	V_R	3	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

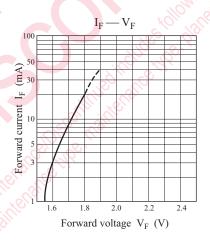
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

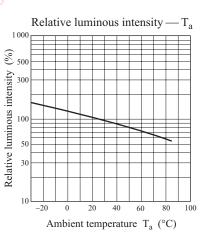
■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

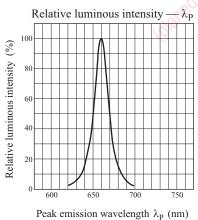
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *	I_{O}	$I_F = 10 \text{ mA}$	17	32	50	mcd
Reverse current	I_R	$V_R = 3 V$	il is	500	100	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$	dillo	1.72	2.50	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$	" IN TO	660		nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	OUL	20		nm

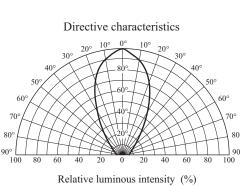
Note) *: Measurement tolerance: ±20%

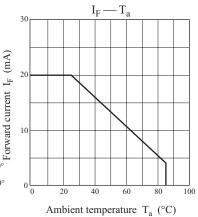










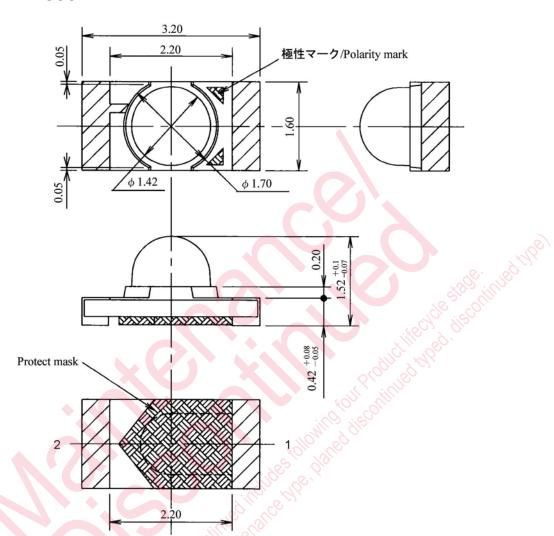


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LNJ218C8ARU Panasonic

■ Package (Unit: mm)

KLTLTN2K1800



- Pin name
 - 1: Anode
 - 2: Cathode

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